



General Description

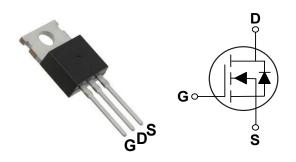
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

| BV _{DSS} | R _{DS(ON)} | I _D |
|-------------------|---------------------|----------------|
| 30 V | 4 mΩ | 140 A |

Features

- $\cdot R_{DS(ON)} \leq 4m\Omega@V_{GS} = 10V$
- · Improved dv/dt capability
- · Fast switching
- · Green Device Available

TO-220 Pin Configuration



Applications

- · MB / VGA / Vcore
- POL Applications
- SMPS 2nd SR

| Absolute Maximum Ratings T _c =25°C unless otherwise noted | | | | | | | |
|--|--|------------|-------|--|--|--|--|
| Symbol | Parameter | Rating | Units | | | | |
| V _{DS} | Drain-Source Voltage | 30 | V | | | | |
| V_{GS} | Gate-Source Voltage | ±20 | V | | | | |
| | Drain Current - Continuous (T _C =25°C) | 140 | Α | | | | |
| I _D | Drain Current - Continuous (T _C =100°C) | 89 | Α | | | | |
| I _{DM} | Drain Current - Pulsed (NOTE 1) | 560 | Α | | | | |
| EAS | Single Pulse Avalanche Energy (NOTE 2) | 125 | mJ | | | | |
| IAS | Single Pulse Avalanche Current (NOTE 2) | 50 | Α | | | | |
| P _D | Power Dissipation (T _C =25°C) | 125 | W | | | | |
| ı D | Power Dissipation - Derate above 25°C | 1 | W/°C | | | | |
| T_J | Operating Junction Temperature Range | -55 to 175 | °C | | | | |
| T _{STG} | Storage Temperature Range | -55 to 175 | °C | | | | |
| Marking Code | | DP3904 | | | | | |

| Thermal Characteristics | | | | | | |
|-------------------------|--|--|------|------|--|--|
| Symbol Parameter | | | Max. | Unit | | |
| $R_{\theta JA}$ | Thermal Resistance Junction to Ambient | | 62 | °C/W | | |
| $R_{	heta JC}$ | R _{eJC} Thermal Resistance Junction to Case | | 1 | °C/W | | |





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-------------------|--------------------------------|--|------|------|------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V_{GS} =0V , I_D =250uA | 30 | | | V |
| I _{DSS} | IDrain-Source Leakage Current | V_{DS} =30V , V_{GS} =0V , T_{J} =25°C | | | 1 | uA |
| | | V_{DS} =24V , V_{GS} =0V , T_J =125°C | | | 10 | uA |
| I _{GSS} | Gate-Source Leakage Current | V_{GS} =±20V , V_{DS} =0V | | | ±100 | nA |

On Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---------------------|-----------------------------------|--|------|------|------|-------|
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} =10V , I _D =24A | | | 4 | mΩ |
| DS(ON) | (NOTE 3) | V_{GS} =4.5V , I_D =12A | | | 6 | 11122 |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=250uA$ | 1.2 | 1.6 | 2.5 | V |
| gfs | Forward Transconductance | V_{DS} =10V , I_{D} =10A | | 16 | | S |

Dynamic and switching Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|------------------|---|---|------|------|------|------|
| Q_g | Total Gate Charge (V _{GS} =4.5V) (NOTE 3 \ 4) | V _{DS} =15V , V _{GS} =4.5V , I _D =24A | | 24 | | |
| Q_g | Total Gate Charge | \/ -15\/ \/ -10\/ -24A | | 47 | | nC |
| Q_gs | Gate-Source Charge | V _{DS} =15V , V _{GS} =10V , I _D =24A (NOTE 3 \ 4) | | 5.8 | | |
| Q_{gd} | Gate-Drain Charge | (NOTE 3 \ 4) | | 10 | | |
| $T_{d(on)}$ | Turn-On Delay Time | | | 12.6 | | |
| T_r | Rise Time | V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω | | 19.5 | | ns |
| $T_{d(off)}$ | Turn-Off Delay Time | , I _D =15A (NOTE 3 \ 4) | | 42.8 | | 115 |
| T_f | Fall Time | | | 13.2 | | |
| C_{iss} | Input Capacitance | | | 2200 | | |
| C _{oss} | Output Capacitance | V_{DS} =25V , V_{GS} =0V , F=1MHz | | 280 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 177 | | |
| Rg | Gate resistance | V _{GS} =0V , V _{DS} =0V , F=1MHz | | 2 | | Ω |

Guaranteed Avalanche Energy

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|--------|-------------------------------|--|------|------|------|------|
| EAS | Single Pulse Avalanche Energy | V _{DD} =25V , L=0.1mH , IAS=24A | 31 | | | mJ |

Drain-Source Diode Characteristics and Ratings

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-----------------|--------------------------------|---|------|------|------|------|
| Is | Continuous Source Current | V _G =V _D =0V,Force Current | | | 140 | Α |
| I _{SM} | Pulsed Source Current (NOTE 3) | V _G -V _D -0V , 1 order durient | | - | 280 | Α |
| V_{SD} | Diode Forward Voltage (NOTE 3) | V_{GS} =0V , I_{S} =1A , T_{J} =25 $^{\circ}$ C | | - | 1 | V |
| trr | Reverse Recovery Time | V _R =30V , I _S =10A , | | 130 | | ns |
| Qrr | Reverse Recovery Charge | di/dt=100A/us , T _J =25°C | | 240 | | nC |

NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =50A, R_{G} =25 Ω , Starting T_{J} =25 $^{\circ}$ C.
- 3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 4. Essentially independent of operating temperature.





Characteristics Curves

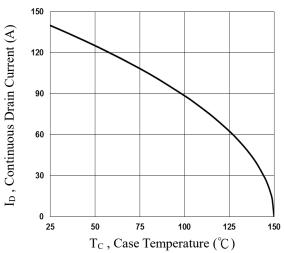


Fig.1 Continuous Drain Current vs. Tc

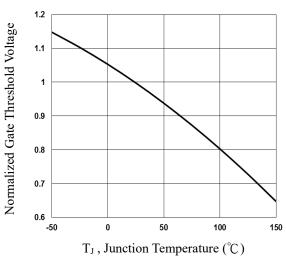


Fig.3 Normalized Vth vs. TJ

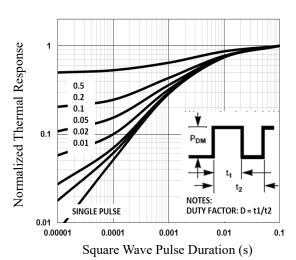


Fig.5 Normalized Transient Impedance

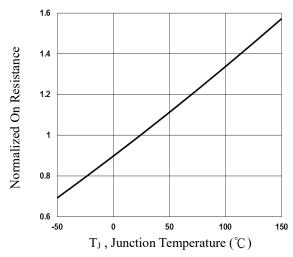


Fig.2 Normalized RDSON vs. T_J

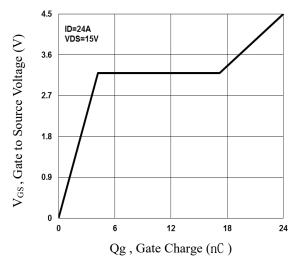


Fig.4 Gate Charge Waveform

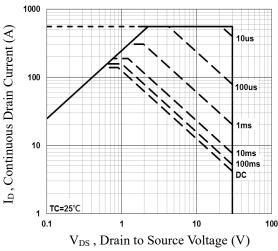


Fig.6 Maximum Safe Operation Area





Characteristics Curves

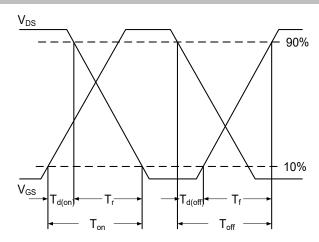
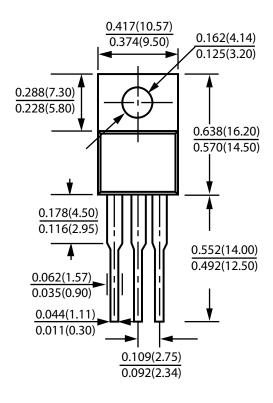
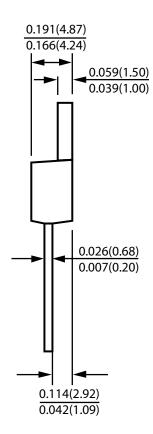


Fig.7 Switching Time Waveform

Package Outline Dimensions





TO-220 Dimensions in inches and (millimeters)





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